

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

Preferred Device

## Ignition IGBT 15 Amps, 410 Volts

### N-Channel DPAK, D<sup>2</sup>PAK and TO-220

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

- Ideal for Coil-on-Plug Applications
- DPAK Package Offers Smaller Footprint and Increased Board Space
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- New Design Increases Unclamped Inductive Switching (UIS) Energy Per Area
- Low Threshold Voltage to Interface Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Optional Gate Resistor ( $R_G$ ) and Gate-Emitter Resistor ( $R_{GE}$ )

#### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

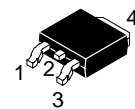
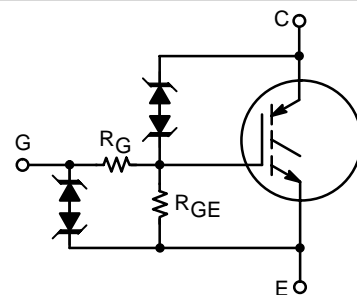
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CES}$	440	$V_{DC}$
Collector-Gate Voltage	$V_{CER}$	440	$V_{DC}$
Gate-Emitter Voltage	$V_{GE}$	15	$V_{DC}$
Collector Current-Continuous @ $T_C = 25^\circ\text{C}$ - Pulsed	$I_C$	15 50	$A_{DC}$ $A_{AC}$
ESD (Human Body Model) $R = 1500 \Omega$ , $C = 100 \text{ pF}$	ESD	8.0	kV
ESD (Machine Model) $R = 0 \Omega$ , $C = 200 \text{ pF}$	ESD	800	V
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	107 1.4	Watts $\text{W}/^\circ\text{C}$
Operating and Storage Temperature Range	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$



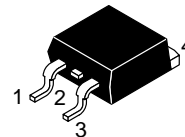
ON Semiconductor™

<http://onsemi.com>

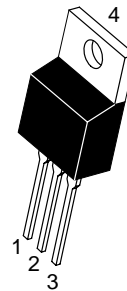
**15 AMPS**  
**410 VOLTS**  
 $V_{CE(on)} \leq 2.1 \text{ V @}$   
 $I_C = 10 \text{ A}, V_{GE} \geq 4.5 \text{ V}$



**DPAK**  
**CASE 369A**  
**STYLE 7**



**D<sup>2</sup>PAK**  
**CASE 418B**  
**STYLE 4**



**TO-220AB**  
**CASE 221A**  
**STYLE 9**

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

#### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 8 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## UNCLAMPED COLLECTOR-TO-EMITTER AVALANCHE CHARACTERISTICS ( $-55^{\circ} \leq T_J \leq 175^{\circ}C$ )

Characteristic	Symbol	Value	Unit
Single Pulse Collector-to-Emitter Avalanche Energy $V_{CC} = 50\text{ V}$ , $V_{GE} = 5.0\text{ V}$ , Pk $I_L = 16.6\text{ A}$ , $L = 1.8\text{ mH}$ , Starting $T_J = 25^{\circ}C$ $V_{CC} = 50\text{ V}$ , $V_{GE} = 5.0\text{ V}$ , Pk $I_L = 15\text{ A}$ , $L = 1.8\text{ mH}$ , Starting $T_J = 125^{\circ}C$	$E_{AS}$	250 200	mJ

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	$^{\circ}C/W$
Thermal Resistance, Junction to Ambient	DPAK (Note 1.) $R_{\theta JA}$	100	$^{\circ}C/W$
	D <sup>2</sup> PAK (Note 1.) $R_{\theta JA}$	50	
	TO-220 $R_{\theta JA}$	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	$T_L$	275	$^{\circ}C$

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Collector-Emitter Clamp Voltage	$BV_{CES}$	$I_C = 2.0\text{ mA}$	$T_J = -40^{\circ}C$ to $150^{\circ}C$	380	410	440	$V_{DC}$
		$I_C = 10\text{ mA}$	$T_J = -40^{\circ}C$ to $150^{\circ}C$	380	410	440	
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 350\text{ V}$ , $V_{GE} = 0\text{ V}$	$T_J = 25^{\circ}C$	-	2.0	20	$\mu A_{DC}$
			$T_J = 150^{\circ}C$	-	10	40*	
			$T_J = -40^{\circ}C$	-	1.0	10	
Reverse Collector-Emitter Leakage Current	$I_{ECS}$	$V_{CE} = -24\text{ V}$	$T_J = 25^{\circ}C$	-	0.7	2.0	mA
			$T_J = 150^{\circ}C$	-	12	25*	
			$T_J = -40^{\circ}C$	-	0.1	1.0	
Reverse Collector-Emitter Clamp Voltage	$BV_{CES(R)}$	$I_C = -75\text{ mA}$	$T_J = 25^{\circ}C$	27	33	37	$V_{DC}$
			$T_J = 150^{\circ}C$	30	36	40	
			$T_J = -40^{\circ}C$	25	31	35	
Gate-Emitter Clamp Voltage	$BV_{GES}$	$I_G = 5.0\text{ mA}$	$T_J = -40^{\circ}C$ to $150^{\circ}C$	11	13	15	$V_{DC}$
Gate-Emitter Leakage Current	$I_{GES}$	$V_{GE} = 10\text{ V}$	$T_J = -40^{\circ}C$ to $150^{\circ}C$	384	640	1000	$\mu A_{DC}$
Gate Resistor (Optional)	$R_G$	-	$T_J = -40^{\circ}C$ to $150^{\circ}C$	-	70	-	$\Omega$
Gate Emitter Resistor	$R_{GE}$	-	$T_J = -40^{\circ}C$ to $150^{\circ}C$	10	16	26	k $\Omega$

### ON CHARACTERISTICS (Note 2.)

Gate Threshold Voltage	$V_{GE(th)}$	$I_C = 1.0\text{ mA}$ , $V_{GE} = V_{CE}$	$T_J = 25^{\circ}C$	1.1	1.4	1.9	$V_{DC}$
			$T_J = 150^{\circ}C$	0.75	1.0	1.4	
			$T_J = -40^{\circ}C$	1.2	1.6	2.1*	
Threshold Temperature Coefficient (Negative)	-	-	-	-	3.4	-	mV/ $^{\circ}C$

1. When surface mounted to an FR4 board using the minimum recommended pad size.

2. Pulse Test: Pulse Width  $\leq 300\ \mu S$ , Duty Cycle  $\leq 2\%$ .

\*Maximum Value of Characteristic across Temperature Range.

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## ELECTRICAL CHARACTERISTICS (continued)

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
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### ON CHARACTERISTICS (continued) (Note 3.)

Collector-to-Emitter On-Voltage	$V_{CE(on)}$	$I_C = 6.0 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.0	1.6	1.8	$V_{DC}$
			$T_J = 150^\circ\text{C}$	0.9	1.5	1.8	
			$T_J = -40^\circ\text{C}$	1.1	1.65	1.9*	
		$I_C = 8.0 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.3	1.8	2.0*	
			$T_J = 150^\circ\text{C}$	1.2	1.7	1.9	
			$T_J = -40^\circ\text{C}$	1.4	1.8	2.0*	
		$I_C = 10 \text{ A}$ , $V_{GE} = 4.0 \text{ V}$	$T_J = 25^\circ\text{C}$	1.4	2.0	2.2	
			$T_J = 150^\circ\text{C}$	1.5	2.0	2.3*	
			$T_J = -40^\circ\text{C}$	1.4	2.0	2.2	
		$I_C = 10 \text{ A}$ , $V_{GE} = 4.5 \text{ V}$	$T_J = 25^\circ\text{C}$	1.3	1.9	2.1	
			$T_J = 150^\circ\text{C}$	1.3	1.9	2.1	
			$T_J = -40^\circ\text{C}$	1.4	1.95	2.1*	
Forward Transconductance	gfs	$V_{CE} = 5.0 \text{ V}$ , $I_C = 6.0 \text{ A}$	$T_J = -40^\circ\text{C}$ to $150^\circ\text{C}$	8.0	15	25	Mhos

### DYNAMIC CHARACTERISTICS

Input Capacitance	$C_{ISS}$	$V_{CC} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ $f = 1.0 \text{ MHz}$	$T_J = -40^\circ\text{C}$ to $150^\circ\text{C}$	400	650	1000	pF
Output Capacitance	$C_{OSS}$			30	55	100	
Transfer Capacitance	$C_{RSS}$			3.0	4.5	8.0	

### SWITCHING CHARACTERISTICS

Turn-Off Delay Time (Inductive)	$t_{d(off)}$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $L = 300 \mu\text{H}$	$T_J = 25^\circ\text{C}$	–	4.0	10	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	4.5	10	
Fall Time (Inductive)	$t_f$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $L = 300 \mu\text{H}$	$T_J = 25^\circ\text{C}$	–	6.0	12	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	10	12	
Turn-Off Delay Time (Resistive)	$t_{d(off)}$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 46 \Omega$	$T_J = 25^\circ\text{C}$	–	3.0	10	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	3.5	10	
Fall Time (Resistive)	$t_f$	$V_{CC} = 300 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 46 \Omega$	$T_J = 25^\circ\text{C}$	–	8.0	15	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	12	15	
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 10 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 1.5 \Omega$	$T_J = 25^\circ\text{C}$	–	0.7	4.0	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	0.7	4.0	
Rise Time	$t_r$	$V_{CC} = 10 \text{ V}$ , $I_C = 6.5 \text{ A}$ $R_G = 1.0 \text{ k}\Omega$ , $R_L = 1.5 \Omega$	$T_J = 25^\circ\text{C}$	–	4.0	7.0	$\mu\text{Sec}$
			$T_J = 150^\circ\text{C}$	–	5.0	7.0	

3. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

\*Maximum Value of Characteristic across Temperature Range.

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## TYPICAL ELECTRICAL CHARACTERISTICS (unless otherwise noted)

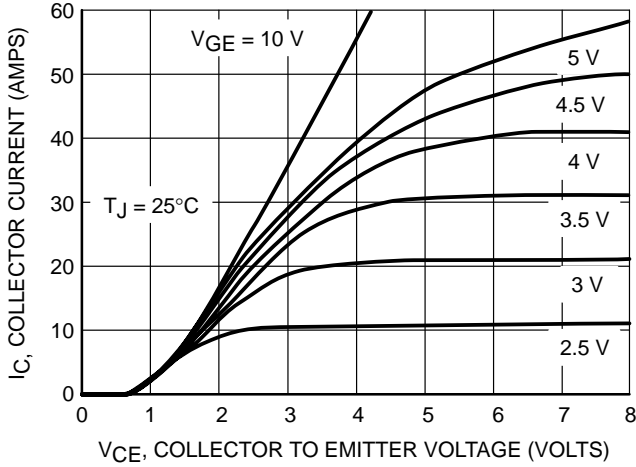


Figure 1. Output Characteristics

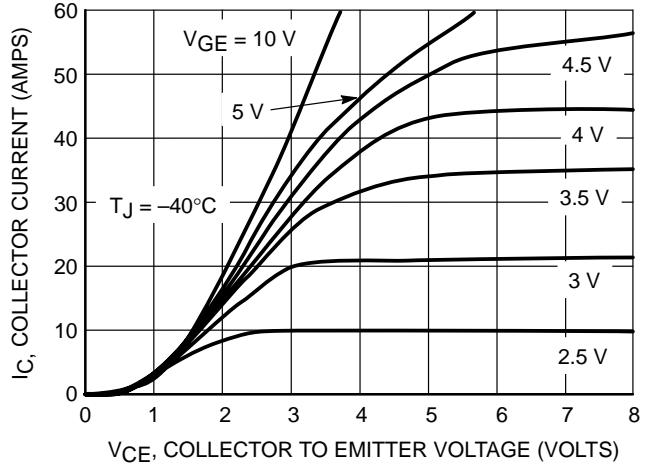


Figure 2. Output Characteristics

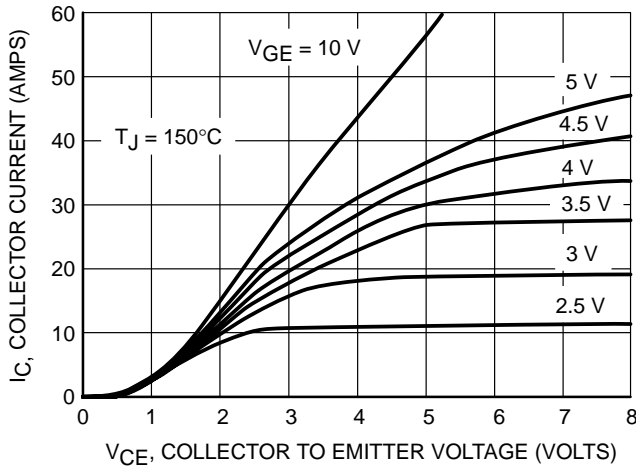


Figure 3. Output Characteristics

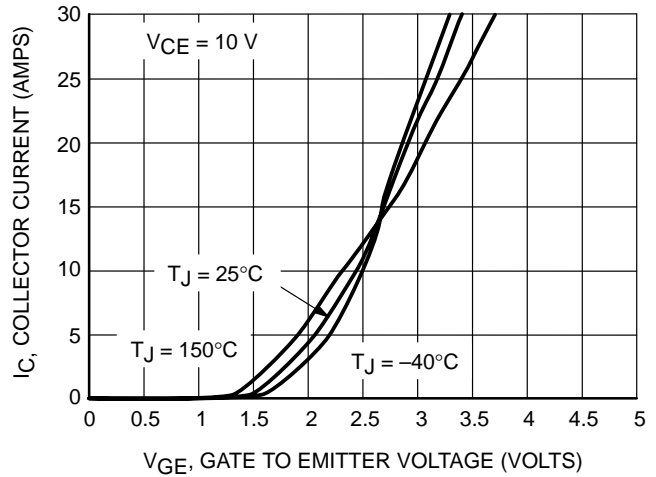


Figure 4. Transfer Characteristics

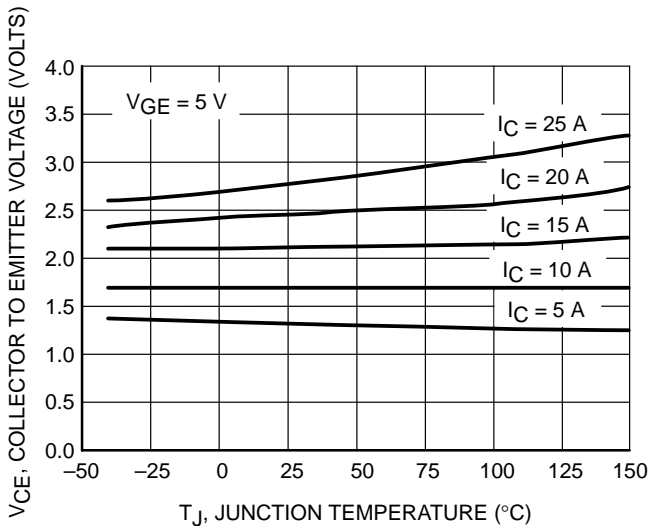


Figure 5. Collector-to-Emitter Saturation Voltage versus Junction Temperature

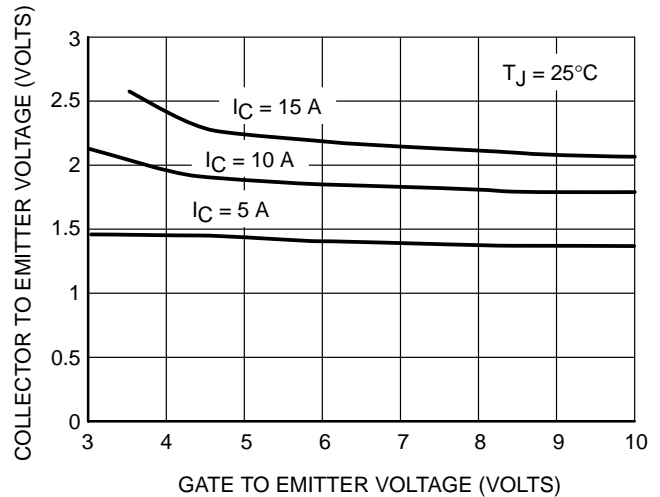


Figure 6. Collector-to-Emitter Voltage versus Gate-to-Emitter Voltage

NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

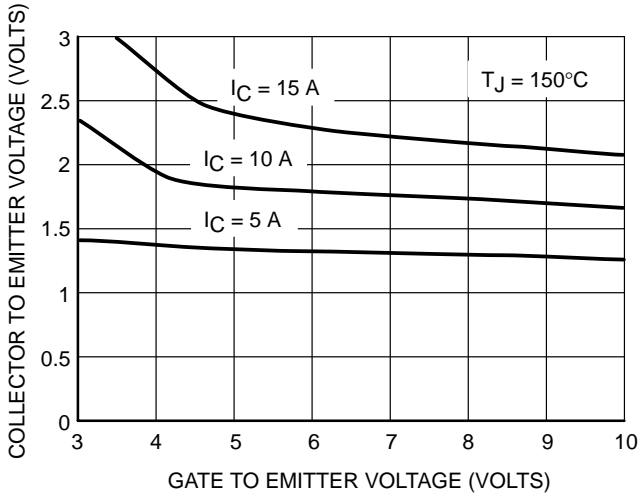


Figure 7. Collector-to-Emitter Voltage versus Gate-to-Emitter Voltage

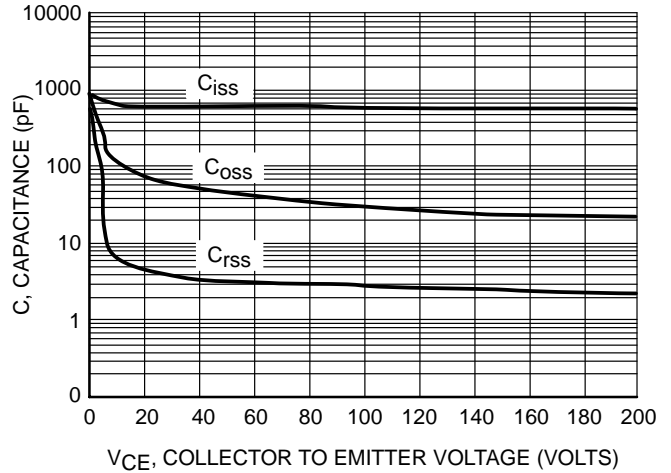


Figure 8. Capacitance Variation

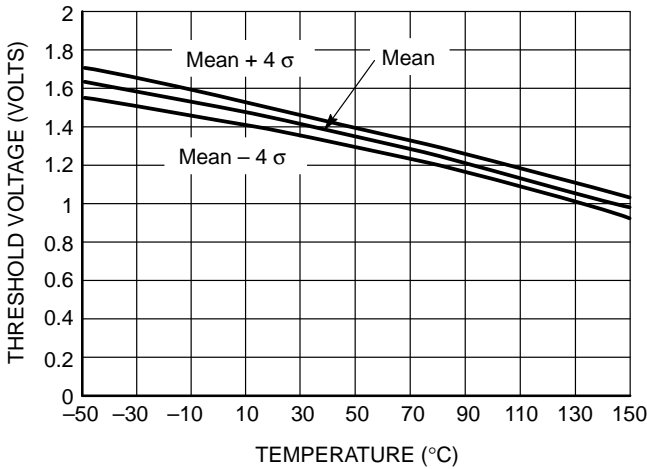


Figure 9. Gate Threshold Voltage versus Temperature

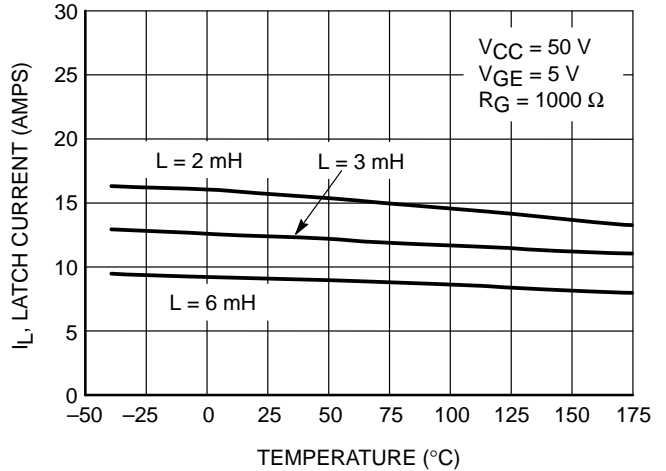


Figure 10. Minimum Open Secondary Latch Current versus Temperature

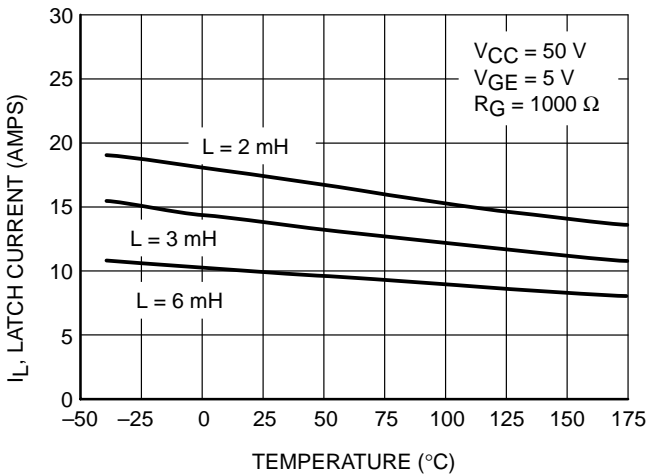


Figure 11. Typical Open Secondary Latch Current versus Temperature

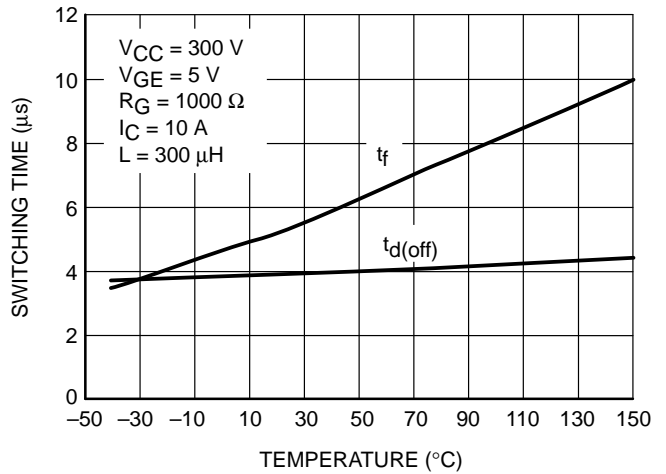


Figure 12. Inductive Switching Fall Time versus Temperature

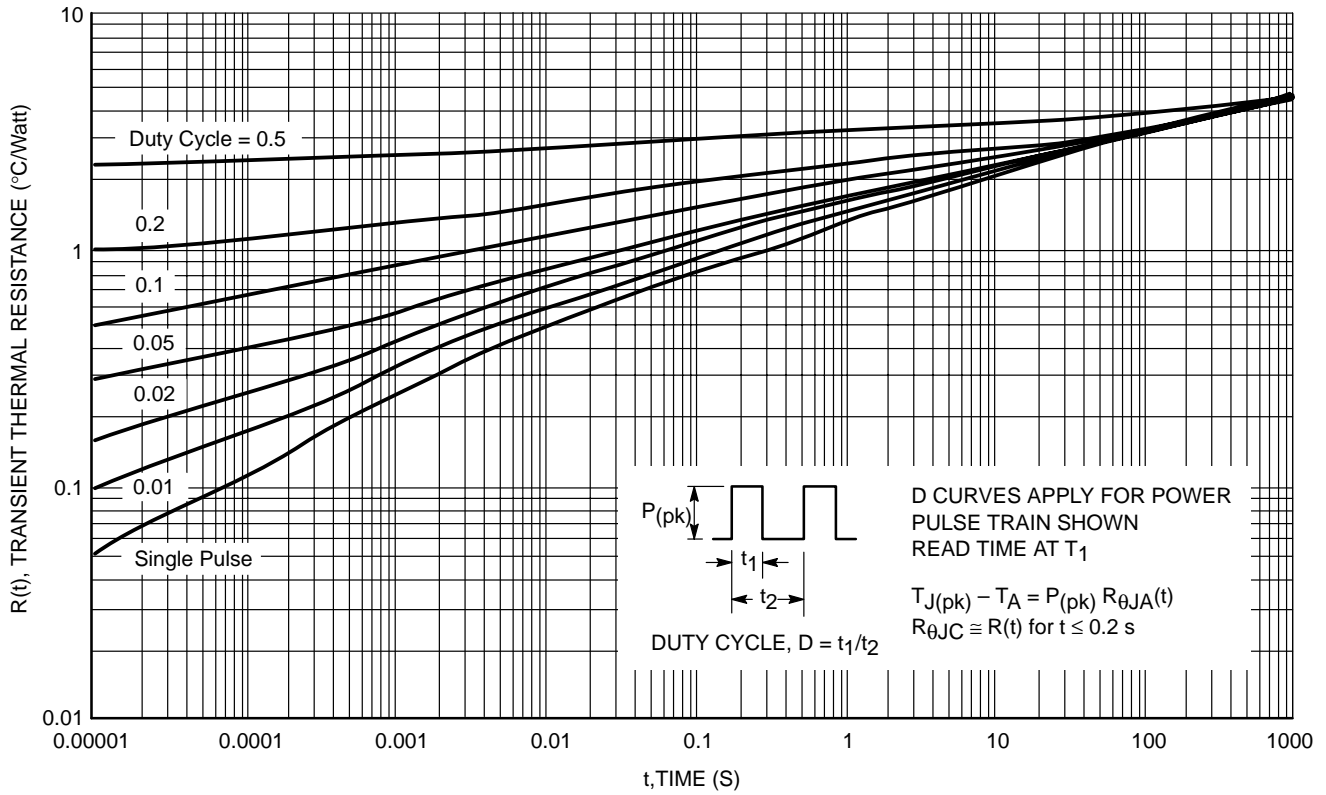


Figure 13. Transient Thermal Resistance (Non-normalized Junction-to-Ambient mounted on fixture in Figure 14)

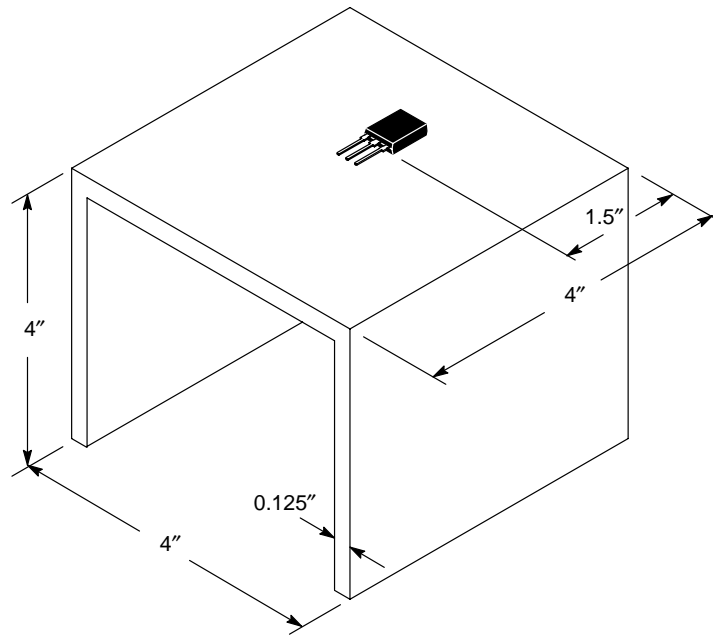


Figure 14. Test Fixture for Transient Thermal Curve (48 square inches of 1/8" thick aluminum)

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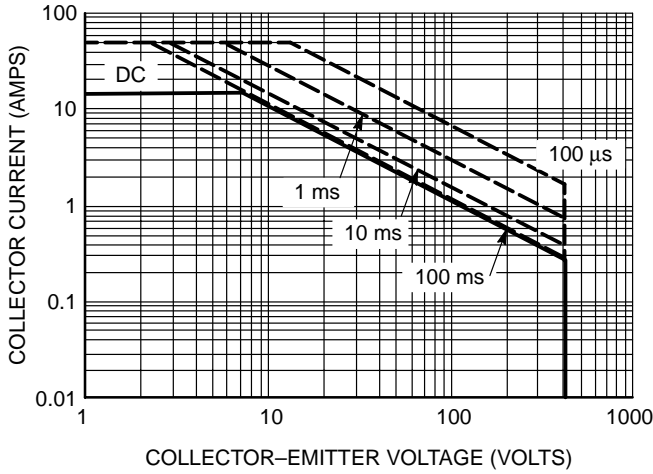


Figure 15. Single Pulse Safe Operating Area (Mounted on an Infinite Heatsink at  $T_A = 25^\circ\text{C}$ )

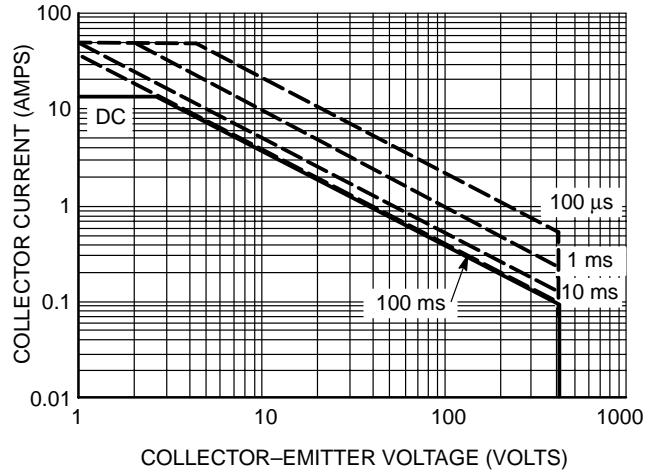


Figure 16. Single Pulse Safe Operating Area (Mounted on an Infinite Heatsink at  $T_A = 125^\circ\text{C}$ )

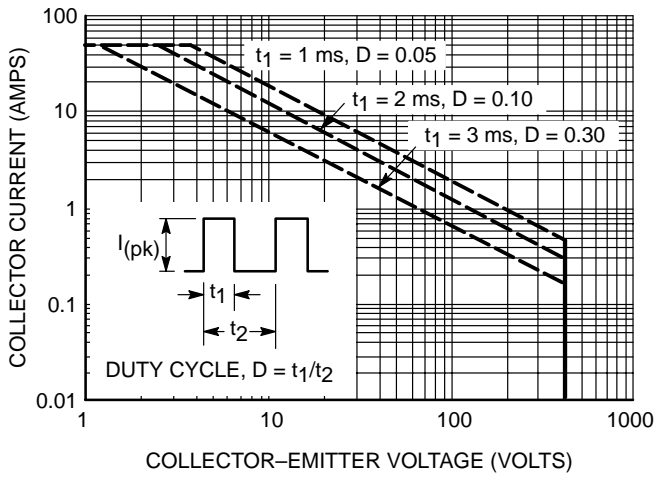


Figure 17. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at  $T_C = 25^\circ\text{C}$ )

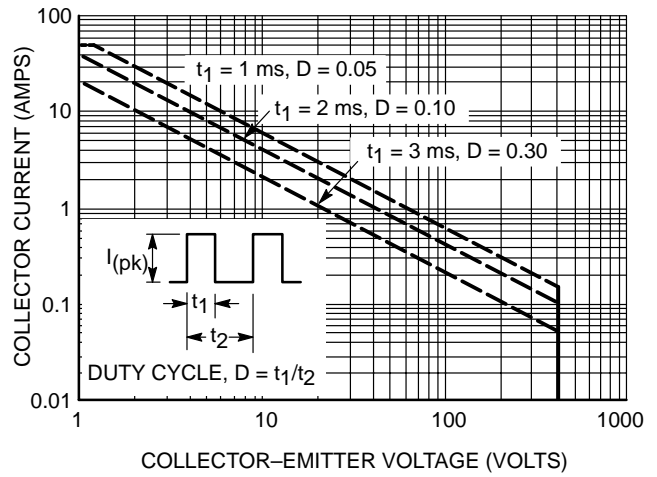


Figure 18. Pulse Train Safe Operating Area (Mounted on an Infinite Heatsink at  $T_C = 125^\circ\text{C}$ )

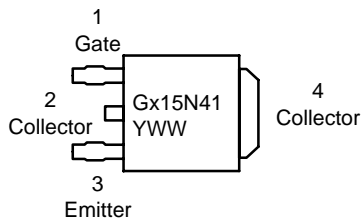
# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## ORDERING INFORMATION

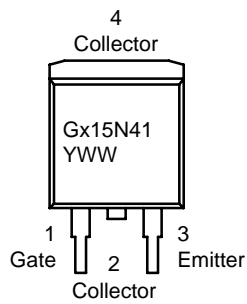
Device	Package Type	Shipping
NGD15N41CL	DPAK	75 Units/Rail
NGD15N41CLT4	DPAK	2500/Tape & Reel
NGB15N41CLT4	D <sup>2</sup> PAK	800/Tape & Reel
NGP15N41CL	TO-220	50 Units/Rail

## MARKING DIAGRAMS

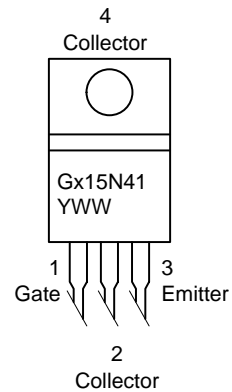
**DPAK  
CASE 369A  
STYLE 7**



**D<sup>2</sup>PAK  
CASE 418B  
STYLE 4**



**TO-220AB  
CASE 221A  
STYLE 9**



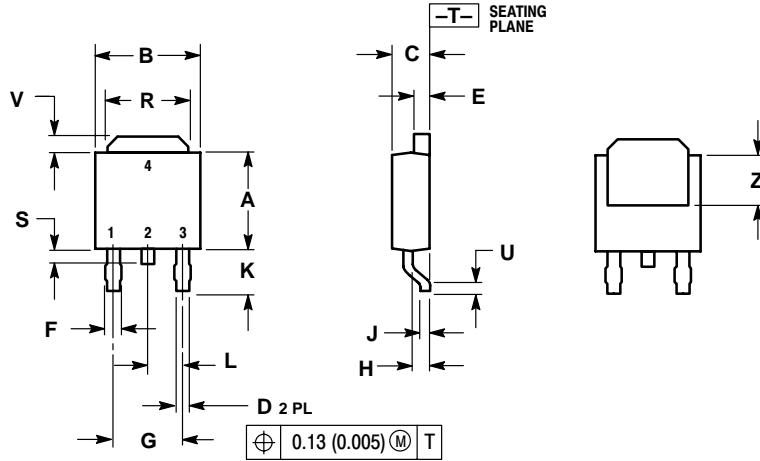
Gx15N41 = Device Code  
 x = D, B, or P  
 Y = Year  
 WW = Work Week



# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## PACKAGE DIMENSIONS

DPAK  
CASE 369A-13  
ISSUE AB



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

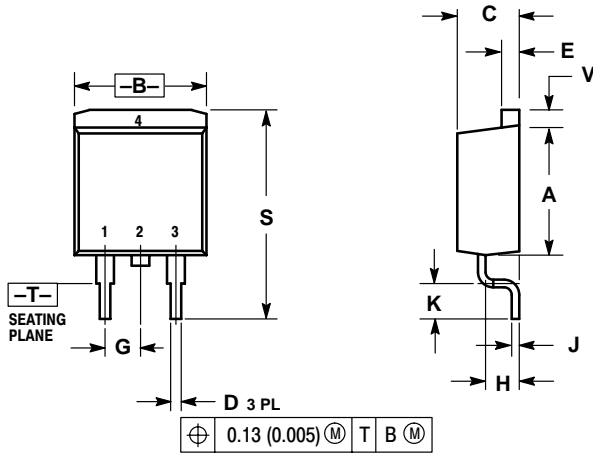
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	---	0.51	---
V	0.030	0.050	0.77	1.27
Z	0.138	---	3.51	---

- STYLE 7:  
PIN 1. GATE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## PACKAGE DIMENSIONS

**D2PAK**  
CASE 418B-03  
ISSUE D



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

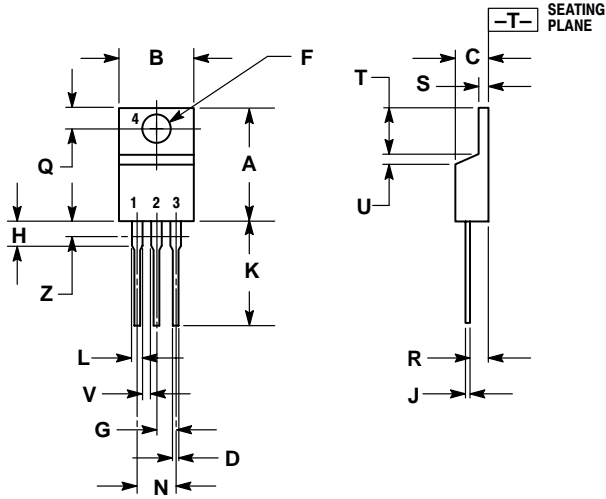
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

- STYLE 4:  
PIN 1. GATE  
2. COLLECTOR  
3. EMITTER  
4. COLLECTOR

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

## PACKAGE DIMENSIONS

TO-220 THREE-LEAD  
TO-220AB  
CASE 221A-09  
ISSUE AA



NOTES:


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 9:

- PIN 1. GATE
- COLLECTOR
- EMITTER
- COLLECTOR

# NGD15N41CLT4, NGB15N41CLT4, NGP15N41CL

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